

## Bias-Dependent Microwave Characteristics of Atomic Planar-Doped AlGaAs/InGaAs/GaAs Double Heterojunction MODFET's (Short Papers)

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Double heterojunction AlGaAs/InGaAs/GaAs modulation-doped field effect transistors (MODFET's) using lattice-strained AlGaAs/InGaAs/GaAs layer structure have been fabricated and evaluated at microwave frequencies for various bias conditions. MODFET's with a 1- $\mu\text{m}$  gate length show a room-temperature peak extrinsic dc transconductance ( $g_{\text{sub m/}}$ ) of 400 mS/mm with a full channel current of 610 mA/mm. For 0.3- $\mu\text{m}$ -gate MODFET's an extrinsic dc  $g_{\text{sub m/}}$  of 505 mS/mm and a full channel current of 720 mA/mm were obtained. Devices having a 1- $\mu\text{m}$  gate length show a maximum available gain cutoff frequency ( $f_{\text{sub max/}}$ ) of 85 GHz and a current-gain cutoff frequency ( $f_{\text{sub T/}}$ ) of 22 GHz from S-parameter measurements. The 0.3- $\mu\text{m}$  devices show an  $f_{\text{sub T/}}$  of 45 GHz and an  $f_{\text{sub max/}}$  of 120 GHz. Bias-dependent equivalent circuit models are also discussed.

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